



Vishay Siliconix

COMPLIANT

HALOGEN FREE

# **Dual N-Channel 20-V (D-S) MOSFET**

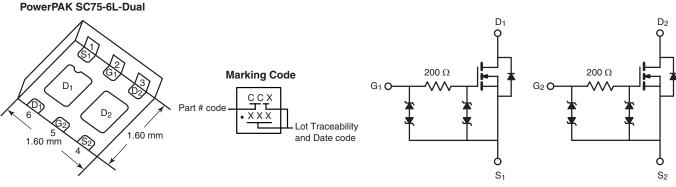
PRODUCT SUMMARY									
V <sub>DS</sub> (V)	$R_{DS(on)}(\Omega)$	I <sub>D</sub> (A) <sup>a</sup>	Q <sub>g</sub> (Typ.)						
20	0.225 at V <sub>GS</sub> = 4.5 V	1.5							
	0.270 at V <sub>GS</sub> = 2.5 V	1.5	1.1 nC						
	0.345 at V <sub>GS</sub> = 1.8 V		1.1110						
	0.960 at V <sub>GS</sub> = 1.5 V	0.5							

#### **FEATURES**

- Halogen-free According to IEC 61249-2-21 Definition
- TrenchFET<sup>®</sup> Power MOSFET
- New Thermally Enhanced PowerPAK<sup>®</sup> SC-75 Package
  - Small Footprint Area
  - Low On-Resistance
  - Thin 0.75 mm Profile
- Typical ESD Protection 2800 V
- Rated ESD Protection 1400 V
- Compliant to RoHS Directive 2002/95/EC

#### **APPLICATIONS**

- Load Switch for Portable Devices
- · Low Voltage Load Switch



Ordering Information: SiB900EDK-T1-GE3 (Lead (Pb)-free and Halogen-free)

Parameter		Symbol	Limit	Unit
Drain-Source Voltage		$V_{DS}$	20	V
Gate-Source Voltage		$V_{GS}$	± 6	V
	T <sub>C</sub> = 25 °C		1.5 <sup>a</sup>	
Continuous Drain Current (T <sub>.1</sub> = 150 °C)	T <sub>C</sub> = 70 °C		1.5 <sup>a</sup>	
Continuous Diain Current (1) = 150 C)	T <sub>A</sub> = 25 °C	- I <sub>D</sub>	1.5 <sup>a, b, c</sup>	
	T <sub>A</sub> = 70 °C		1.3 <sup>b, c</sup>	A
Pulsed Drain Current		I <sub>DM</sub>	4	
Continuous Source-Drain Diode Current	T <sub>C</sub> = 25 °C	I.	1.5 <sup>a</sup>	
Continuous Source-Diain Diode Current	T <sub>A</sub> = 25 °C	I <sub>S</sub>	0.9 <sup>b, c</sup>	
	T <sub>C</sub> = 25 °C		3.1	
Maximum Power Dissipation	T <sub>C</sub> = 70 °C	P <sub>D</sub>	2	w
Maximum Fower Dissipation	T <sub>A</sub> = 25 °C	' D	1.1 <sup>b, c</sup>	VV
	T <sub>A</sub> = 70 °C		0.7 <sup>b, c</sup>	
Operating Junction and Storage Temperature Ra	T <sub>J</sub> , T <sub>stg</sub>	- 55 to 150	°C	
Soldering Recommendations (Peak Temperature	e) <sup>d, e</sup>		260	

Document Number: 64808 S09-0667-Rev. A, 20-Apr-09

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THERMAL RESISTANCE RATINGS									
Parameter		Symbol	Typical	ypical Maximum Uni					
Maximum Junction-to-Ambient <sup>b, f</sup>	t ≤ 5 s	R <sub>thJA</sub>	90	115	°C/W				
Maximum Junction-to-Case (Drain)	Steady State	R <sub>thJC</sub>	32	40	O/ <b>V</b> V				

#### Notes:

- a. Package limited.
- b. Surface Mounted on 1" x 1" FR4 board.
- c. t = 5 s.
- d. See Solder Profile (<a href="https://www.vishay.com/ppg?73257">www.vishay.com/ppg?73257</a>). The PowerPAK SC-75 is a leadless package. The end of the lead terminal is exposed copper (not plated) as a result of the singulation process in manufacturing. A solder fillet at the exposed copper tip cannot be guaranteed and is not required to ensure adequate bottom side solder interconnection.
- e. Rework Conditions: manual soldering with a soldering iron is not recommended for leadless components.
- f. Maximum under Steady State conditions is 125 °C/W.

Parameter	Symbol	nbol Test Conditions		Тур.	Max.	Unit	
Static	•		1				
Drain-Source Breakdown Voltage	V <sub>DS</sub>	$V_{GS} = 0 \text{ V}, I_D = 250 \mu\text{A}$	20			V	
V <sub>DS</sub> Temperature Coefficient	$\Delta V_{DS}/T_{J}$	I <sub>D</sub> = 250 μA		21			
V <sub>GS(th)</sub> Temperature Coefficient	$\Delta V_{GS(th)}/T_J$	I <sub>D</sub> = 250 μA		- 2.3		mV/°C	
Gate-Source Threshold Voltage	V <sub>GS(th)</sub>	$V_{DS} = V_{GS}, I_{D} = 250 \mu A$	0.4		1.0	V	
Coto Course Legisere	_	$V_{DS} = 0 \text{ V}, V_{GS} = \pm 3 \text{ V}$			± 1	μΑ	
Gate-Source Leakage	I <sub>GSS</sub>	$V_{DS} = 0 \text{ V}, V_{GS} = \pm 6 \text{ V}$			± 1	mA	
Zoro Coto Voltago Droin Current	1	$V_{DS} = 20 \text{ V}, V_{GS} = 0 \text{ V}$			1	μΑ	
Zero Gate Voltage Drain Current	I <sub>DSS</sub>	V <sub>DS</sub> = 20 V, V <sub>GS</sub> = 0 V, T <sub>J</sub> = 55 °C			10		
On-State Drain Current <sup>a</sup>	I <sub>D(on)</sub>	$V_{DS} \ge 5 \text{ V}, V_{GS} = 4.5 \text{ V}$	4			Α	
		$V_{GS} = 4.5 \text{ V}, I_D = 1.6 \text{ A}$	V <sub>GS</sub> = 4.5 V, I <sub>D</sub> = 1.6 A 0.183				
D : 0	R <sub>DS(on)</sub>	V <sub>GS</sub> = 2.5 V, I <sub>D</sub> = 1.5 A		0.220	0.270	Ω	
Drain-Source On-State Resistance <sup>a</sup>		V <sub>GS</sub> = 1.8 V, I <sub>D</sub> = 1.3 A		0.275	0.345		
		V <sub>GS</sub> = 1.5 V, I <sub>D</sub> = 0.3 A	V <sub>GS</sub> = 1.5 V, I <sub>D</sub> = 0.3 A 0.320 0.				
Forward Transconductance <sup>a</sup>	9 <sub>fs</sub>	V <sub>DS</sub> = 10 V, I <sub>D</sub> = 1.6 A		3.5		S	
Dynamic <sup>b</sup>							
Total Gate Charge	$Q_g$			1.1	1.7		
Gate-Source Charge	Q <sub>gs</sub>	$V_{DS} = 10 \text{ V}, V_{GS} = 4.5 \text{ V}, I_{D} = 1.7 \text{ A}$		0.2		nC	
Gate-Drain Charge	Q <sub>gd</sub>			0.1			
Gate Resistance	$R_{g}$	f = 1 MHz		200		Ω	
Turn-On Delay Time	t <sub>d(on)</sub>			20	30		
Rise Time	t <sub>r</sub>	$V_{DD} = 10 \text{ V}, R_{L} = 7.7 \Omega$		12	20	ns	
Turn-Off DelayTime	t <sub>d(off)</sub>	$I_D \cong 1.3 \text{ A}, V_{GEN} = 4.5 \text{ V}, R_g = 1 \Omega$		70	105		
Fall Time	t <sub>f</sub>			20	30		
<b>Drain-Source Body Diode Characteristic</b>	s						
Continuous Source-Drain Diode Current	I <sub>S</sub>	T <sub>C</sub> = 25 °C			1.5	А	
Pulse Diode Forward Current	I <sub>SM</sub>				4	^	
Body Diode Voltage	$V_{SD}$	I <sub>S</sub> = 1.3 A, V <sub>GS</sub> = 0 V		0.9	1.2	V	

#### Notes:

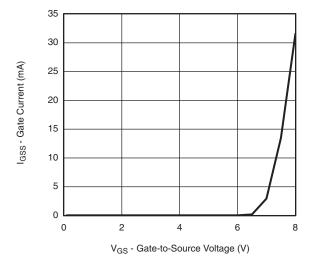
- a. Pulse test; pulse width  $\leq$  300  $\mu$ s, duty cycle  $\leq$  2 %.
- b. Guaranteed by design, not subject to production testing.

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

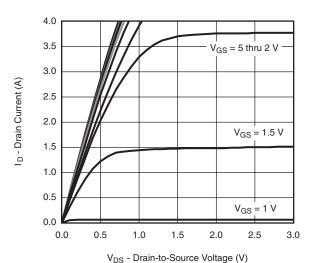


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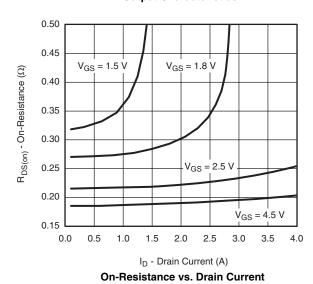
## **TYPICAL CHARACTERISTICS** $T_A = 25$ °C, unless otherwise noted



#### Gate Current vs. Gate-to-Source Voltage

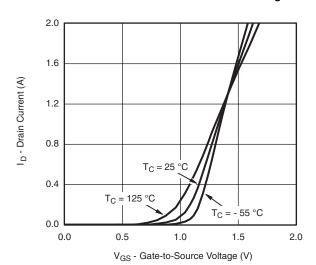


**Output Characteristics** 

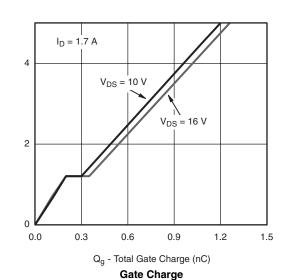


10-1 10-2 10-3 10-4 10-5 10-6 10-7 10-8 10-9 10-10 0 2 4 6 8

 $\label{eq:VGS} V_{GS} \mbox{ - Gate-to-Source Voltage (V)}$   $\mbox{\bf Gate Current vs. Gate-to-Source Voltage}$ 



Transfer Characteristics

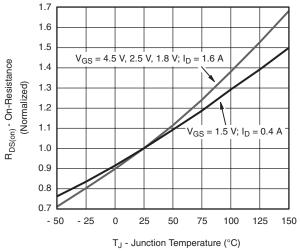


V<sub>GS</sub> - Gate-to-Source Voltage (V)

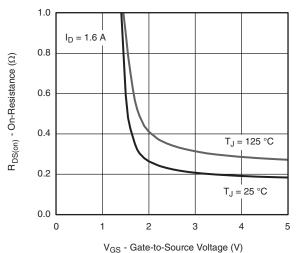
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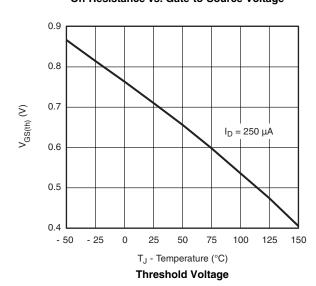
## **TYPICAL CHARACTERISTICS** $T_A = 25$ °C, unless otherwise noted

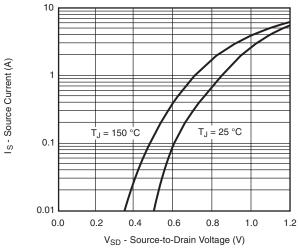


#### Normalized On-Resistance vs. Junction Temperature

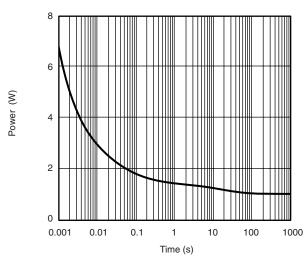


#### On-Resistance vs. Gate-to-Source Voltage

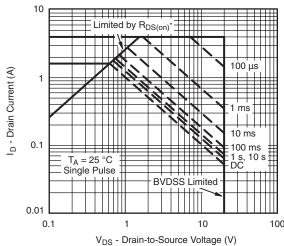




#### Source-Drain Diode Forward Voltage



#### Single Pulse Power, Junction-to-Ambient



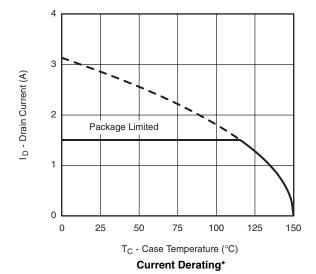
 $v_{DS}$  - Drain-to-Source voltage (v) \*  $V_{GS}$  > minimum  $V_{GS}$  at which  $R_{DS(on)}$  is specified

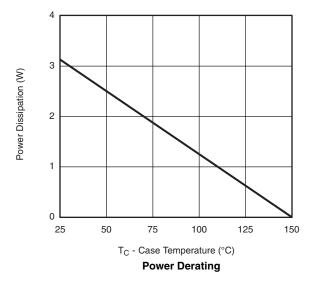
Safe Operating Area, Junction-to-Ambient



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## **TYPICAL CHARACTERISTICS** $T_A = 25$ °C, unless otherwise noted



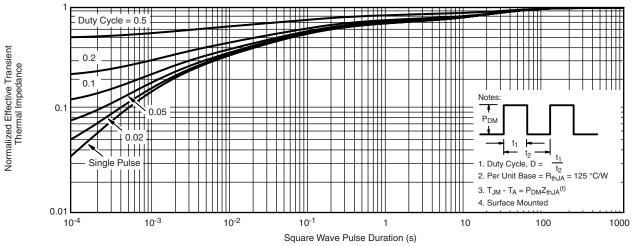


<sup>\*</sup> The power dissipation  $P_D$  is based on  $T_{J(max)} = 150$  °C, using junction-to-case thermal resistance, and is more useful in settling the upper dissipation limit for cases where additional heatsinking is used. It is used to determine the current rating, when this rating falls below the package limit

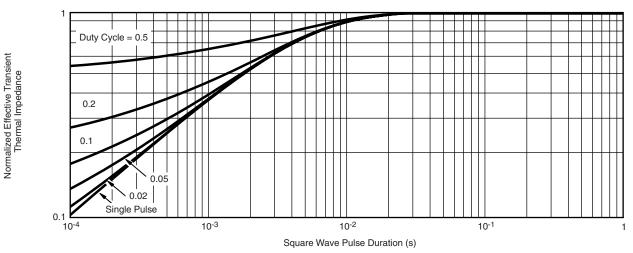
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## **TYPICAL CHARACTERISTICS** $T_A = 25$ °C, unless otherwise noted



#### Normalized Thermal Transient Impedance, Junction-to-Ambient



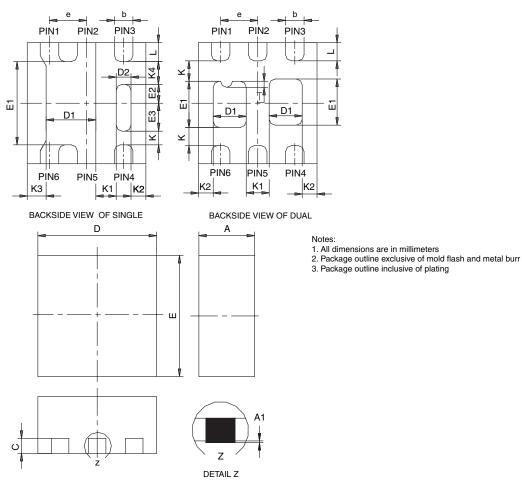
Normalized Thermal Transient Impedance, Junction-to-Case

Vishay Siliconix maintains worldwide manufacturing capability. Products may be manufactured at one of several qualified locations. Reliability data for Silicon Technology and Package Reliability represent a composite of all qualified locations. For related documents such as package/tape drawings, part marking, and reliability data, see <a href="https://www.vishay.com/ppg?64808">www.vishay.com/ppg?64808</a>.





PowerPAK® SC75-6L



		SINGLE PAD						DUAL PAD					
DIM	M	ILLIMETE	TERS INCHES MILLIMETERS			RS		INCHES					
	Min	Nom	Max	Min	Nom	Max	Min	Nom	Max	Min	Nom	Max	
Α	0.675	0.75	0.80	0.027	0.030	0.032	0.675	0.75	0.80	0.027	0.030	0.032	
A1	0	-	0.05	0	-	0.002	0	-	0.05	0	-	0.002	
b	0.18	0.25	0.33	0.007	0.010	0.013	0.18	0.25	0.33	0.007	0.010	0.013	
С	0.15	0.20	0.25	0.006	0.008	0.010	0.15	0.20	0.25	0.006	0.008	0.010	
D	1.53	1.60	1.70	0.060	0.063	0.067	1.53	1.60	1.70	0.060	0.063	0.067	
D1	0.57	0.67	0.77	0.022	0.026	0.030	0.34	0.44	0.54	0.013	0.017	0.021	
D2	0.10	0.20	0.30	0.004	0.008	0.012							
Е	1.53	1.60	1.70	0.060	0.063	0.067	1.53	1.60	1.70	0.060	0.063	0.067	
E1	1.00	1.10	1.20	0.039	0.043	0.047	0.51	0.61	0.71	0.020	0.024	0.028	
E2	0.20	0.25	0.30	0.008	0.010	0.012							
E3	0.32	0.37	0.42	0.013	0.015	0.017							
е		0.50 BSC		0.020 BSC			0.50 BSC			0.020 BSC			
K	0.180 TYP			0.007 TYP		0.245 TYP 0.010 TYP							
K1	0.275 TYP				0.011 TYP 0.320 TYP				0.013 TYP				
K2	0.200 TYP			0.008 TYP			0.200 BSC			0.008 TYP			
K3	0.255 TYP			0.010 TYP			•						
K4	0.300 TYP			0.012 TYP									
L	0.15	0.25	0.35	0.006	0.010	0.014	0.15	0.25	0.35	0.006	0.010	0.014	
T							0.03	0.08	0.13	0.001	0.003	0.005	

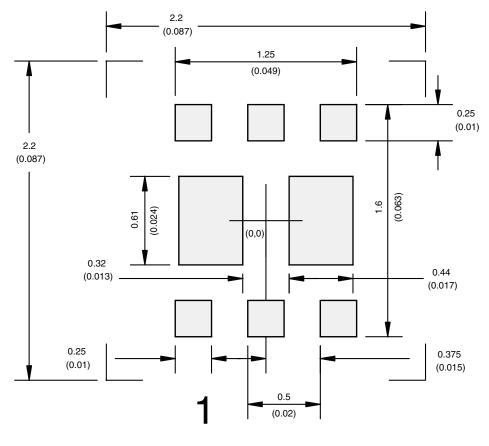
ECN: C-07431 - Rev. C, 06-Aug-07

DWG: 5935

Document Number: 73000 06-Aug-07



#### RECOMMENDED PAD LAYOUT FOR PowerPAK® SC75-6L Dual



Dimensions in mm/(Inches)

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APPLICATION NOTE





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